

## Product Summary

Device	BVDSS	R <sub>D(S(ON)) MAX</sub>	I <sub>D MAX</sub> T <sub>A</sub> = +25°C
N-Channel	12V	25mΩ @ V <sub>GS</sub> = 4.5V	6.9A
		30mΩ @ V <sub>GS</sub> = 2.5V	6.3A
		38mΩ @ V <sub>GS</sub> = 1.8V	5.5A

## Description

This MOSFET is designed to minimize the on-state resistance (R<sub>D(S(ON))</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

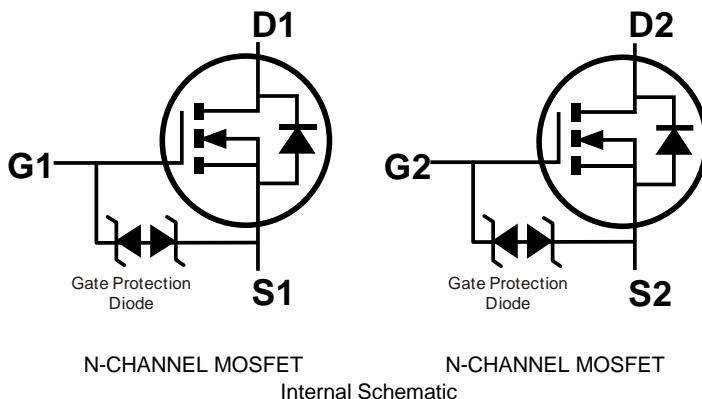
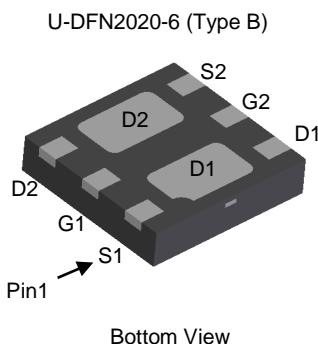
- Load Switch
- Power Management Functions
- Portable Power Adaptors

## Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- ESD Protected Gate
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at  
<https://www.diodes.com/products/automotive/automotive-products/>
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.  
<https://www.diodes.com/quality/product-definitions/>

## Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 <sup>(4)</sup>
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)



## Ordering Information (Note 4)

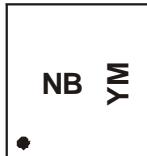
Part Number	Case	Packaging
DMN1025UFDB-7	U-DFN2020-6 (Type B)	3000/Tape & Reel
DMN1025UFDB-13	U-DFN2020-6 (Type B)	10000/Tape & Reel

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information

Site 1



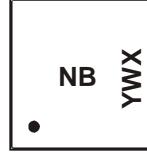
**NB** = Product Type Marking Code  
**YM** = Date Code Marking  
**Y** = Year (ex: H = 2020)  
**M** = Month (ex: 9 = September)

Date Code Key

<b>Year</b>	2013	...	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
<b>Code</b>	A	...	H	I	J	K	L	M	N	O	P	R

<b>Month</b>	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
<b>Code</b>	1	2	3	4	5	6	7	8	9	O	N	D

Site 2



**NB** = Product Type Marking Code  
**YWX** = Date Code Marking  
**Y** = Year (ex: 0 = 2020)  
**W** = Week (ex: a = Week 27; z Represents Week 52 and 53)  
**X** = Internal Code (ex: U = Monday)

Date Code Key

<b>Year</b>	2013	...	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
<b>Code</b>	3	...	0	1	2	3	4	5	6	7	8	9

<b>Week</b>	1-26	27-52	53
<b>Code</b>	A-Z	a-z	z

<b>Internal Code</b>	<b>Sun</b>	<b>Mon</b>	<b>Tue</b>	<b>Wed</b>	<b>Thu</b>	<b>Fri</b>	<b>Sat</b>
<b>Code</b>	T	U	V	W	X	Y	Z

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			$V_{DSS}$	12	V
Gate-Source Voltage			$V_{GSS}$	$\pm 10$	V
Continuous Drain Current (Note 5) $V_{GS} = 4.5\text{V}$	Steady State	$T_A = +25^\circ\text{C}$ $T_A = +70^\circ\text{C}$	$I_D$	6.9 5.5	A
	$t < 5\text{s}$	$T_A = +25^\circ\text{C}$ $T_A = +70^\circ\text{C}$	$I_D$	8.8 7.0	A
Maximum Continuous Body Diode Forward Current (Note 5)			$I_S$	1	A
Pulsed Drain Current (10 $\mu\text{s}$ Pulse, Duty Cycle = 1%)			$I_{DM}$	35	A
Avalanche Current (Note 6) $L = 0.1\text{mH}$			$I_{AS}$	9.8	A
Avalanche Energy (Note 6) $L = 0.1\text{mH}$			$E_{AS}$	4.8	mJ

**Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	Steady State	$P_D$	1.7	W
	$t < 5\text{s}$		2.9	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	71	$^\circ\text{C/W}$
	$t < 5\text{s}$		43	
Thermal Resistance, Junction to Case (Note 5)		$R_{\theta JC}$	13	
Operating and Storage Temperature Range		$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

**Electrical Characteristics N-CHANNEL** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 7)</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	12	—	—	V	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$
Zero Gate Voltage Drain Current $T_J = +25^\circ\text{C}$	$I_{DSS}$	—	—	1.0	$\mu\text{A}$	$V_{DS} = 12\text{V}, V_{GS} = 0\text{V}$
Gate-Source Leakage	$I_{GSS}$	—	—	$\pm 10$	$\mu\text{A}$	$V_{GS} = \pm 8\text{V}, V_{DS} = 0\text{V}$
<b>ON CHARACTERISTICS (Note 7)</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	0.4	—	1	V	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	—	18	25	$\text{m}\Omega$	$V_{GS} = 4.5\text{V}, I_D = 5.2\text{A}$
		—	20	30		$V_{GS} = 2.5\text{V}, I_D = 4.8\text{A}$
		—	25	38		$V_{GS} = 1.8\text{V}, I_D = 2.5\text{A}$
Diode Forward Voltage	$V_{SD}$	—	0.7	1.2	V	$V_{GS} = 0\text{V}, I_S = 5.4\text{A}$
<b>DYNAMIC CHARACTERISTICS (Note 8)</b>						
Input Capacitance	$C_{iss}$	—	917	—	$\text{pF}$	$V_{DS} = 6\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$
Output Capacitance	$C_{oss}$	—	120	—	$\text{pF}$	
Reverse Transfer Capacitance	$C_{rss}$	—	102	—	$\text{pF}$	
Gate Resistance	$R_g$	—	11.4	—	$\Omega$	
Total Gate Charge ( $V_{GS} = 4.5\text{V}$ )	$Q_g$	—	12.6	—	$\text{nC}$	$V_{DS} = 0\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$
Total Gate Charge ( $V_{GS} = 8\text{V}$ )		—	23.1	—	$\text{nC}$	
Gate-Source Charge	$Q_{gs}$	—	1.3	—	$\text{nC}$	$V_{DS} = 10\text{V}, I_D = 6.8\text{A}$
Gate-Drain Charge	$Q_{gd}$	—	1.6	—	$\text{nC}$	
Turn-On Delay Time	$t_{D(ON)}$	—	3.0	—	ns	$V_{DD} = 6\text{V}, V_{GS} = 4.5\text{V}, R_L = 1.1\Omega, R_g = 1\Omega$
Turn-On Rise Time	$t_R$	—	9.3	—	ns	
Turn-Off Delay Time	$t_{D(OFF)}$	—	17.2	—	ns	
Turn-Off Fall Time	$t_F$	—	2.8	—	ns	
Body Diode Reverse Recovery Time	$t_{RR}$	—	6.8	—	ns	$I_S = 5.4\text{A}, dI/dt = 100\text{A}/\mu\text{s}$
Body Diode Reverse Recovery Charge	$Q_{RR}$	—	1.1	—	$\text{nC}$	$I_S = 5.4\text{A}, dI/dt = 100\text{A}/\mu\text{s}$

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

 6.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25^\circ\text{C}$ .

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

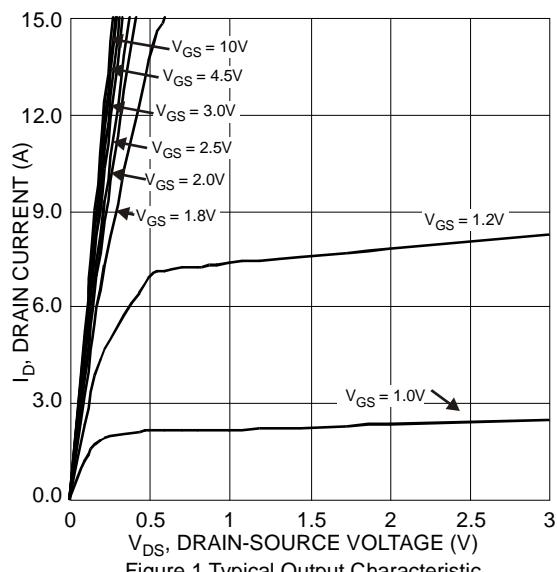


Figure 1 Typical Output Characteristic

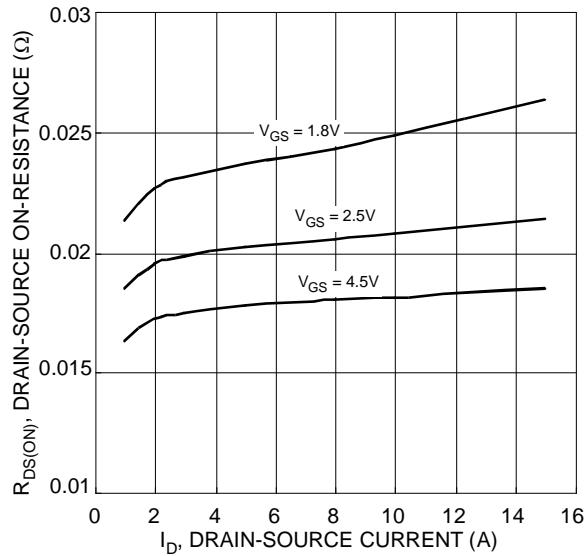


Figure 3 Typical On-Resistance vs.  
Drain Current and Gate Voltage

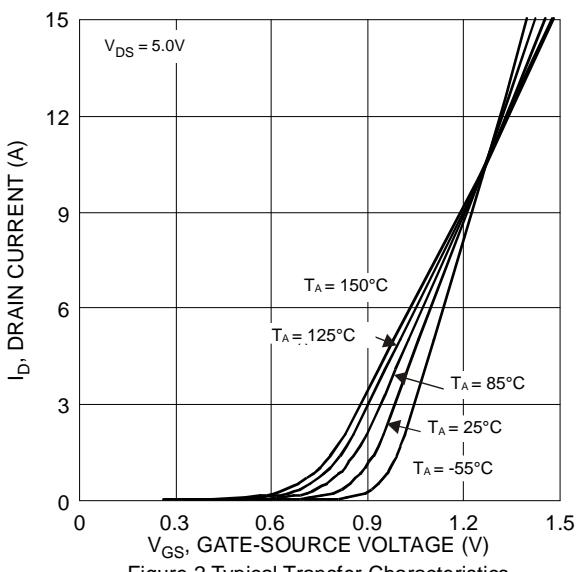


Figure 2 Typical Transfer Characteristics

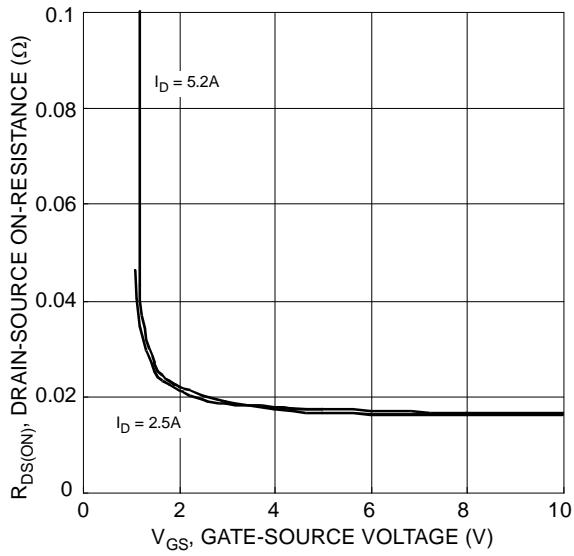


Figure 4 Typical Transfer Characteristic

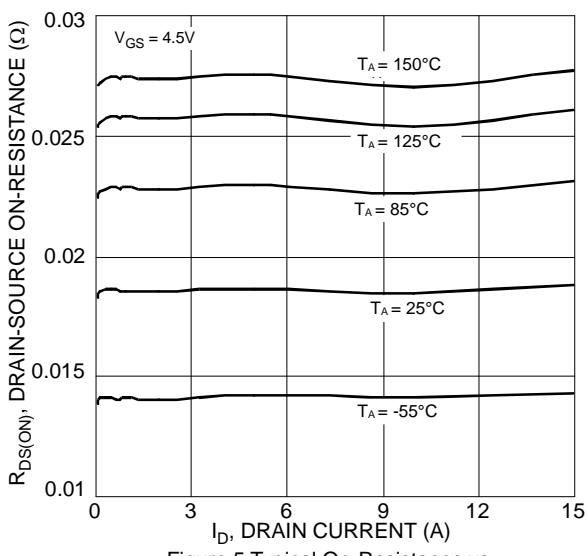


Figure 5 Typical On-Resistance vs.  
Drain Current and Temperature

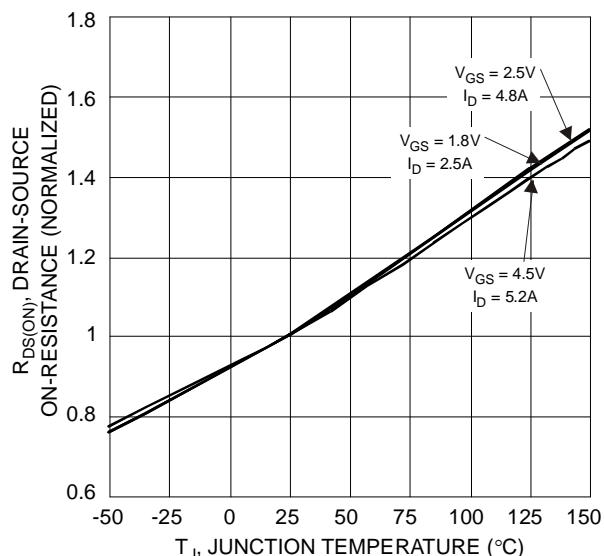
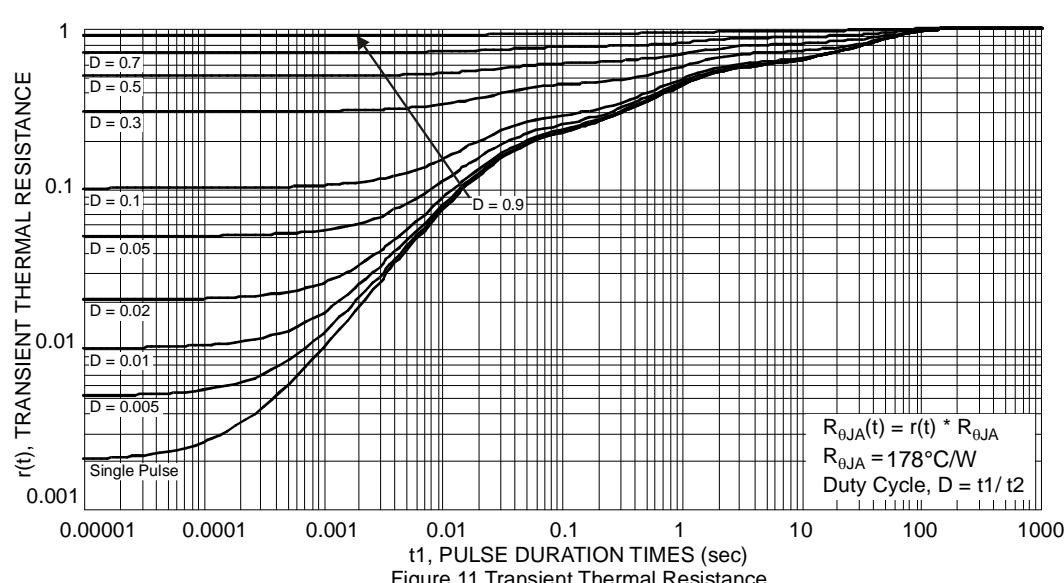
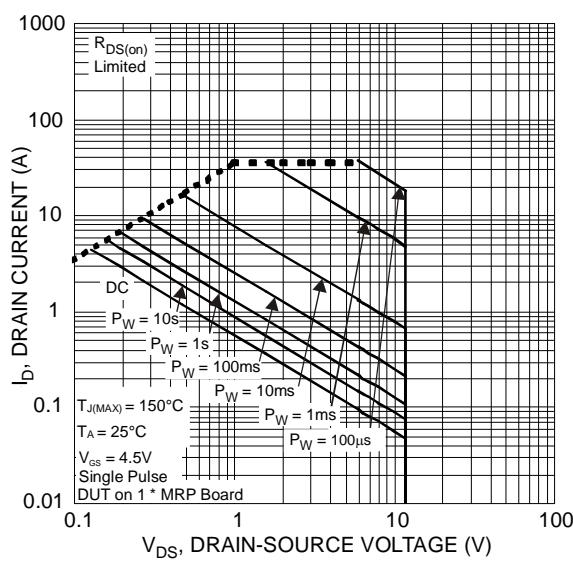
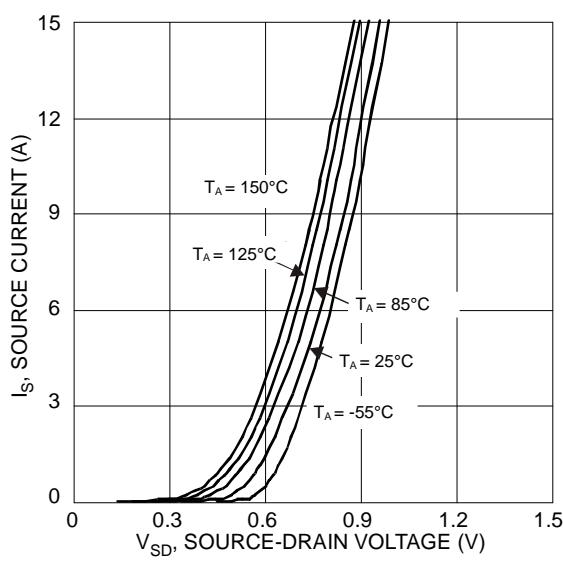
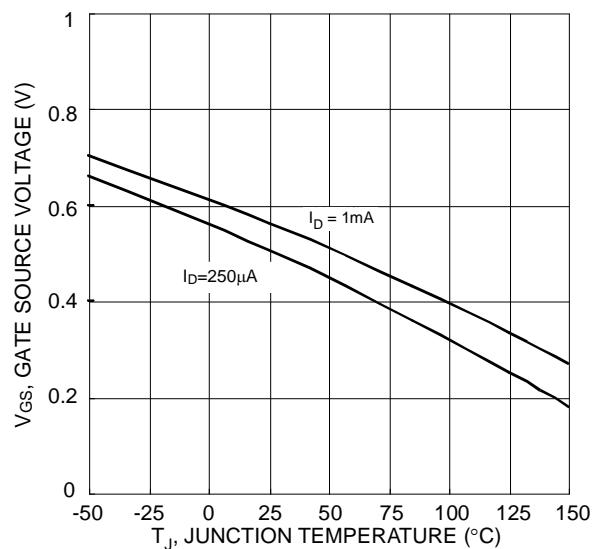
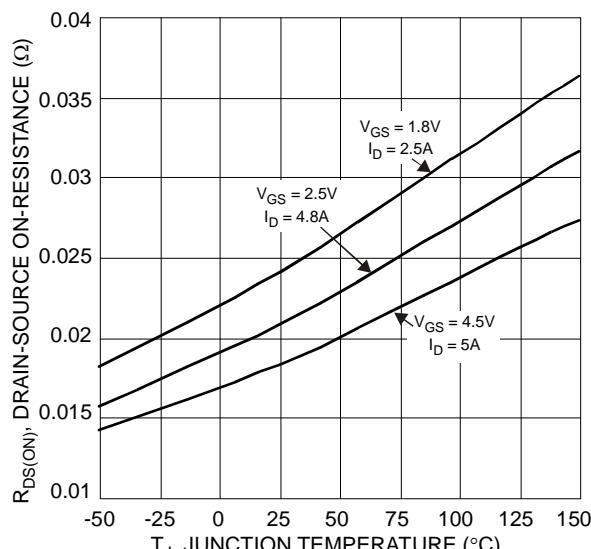
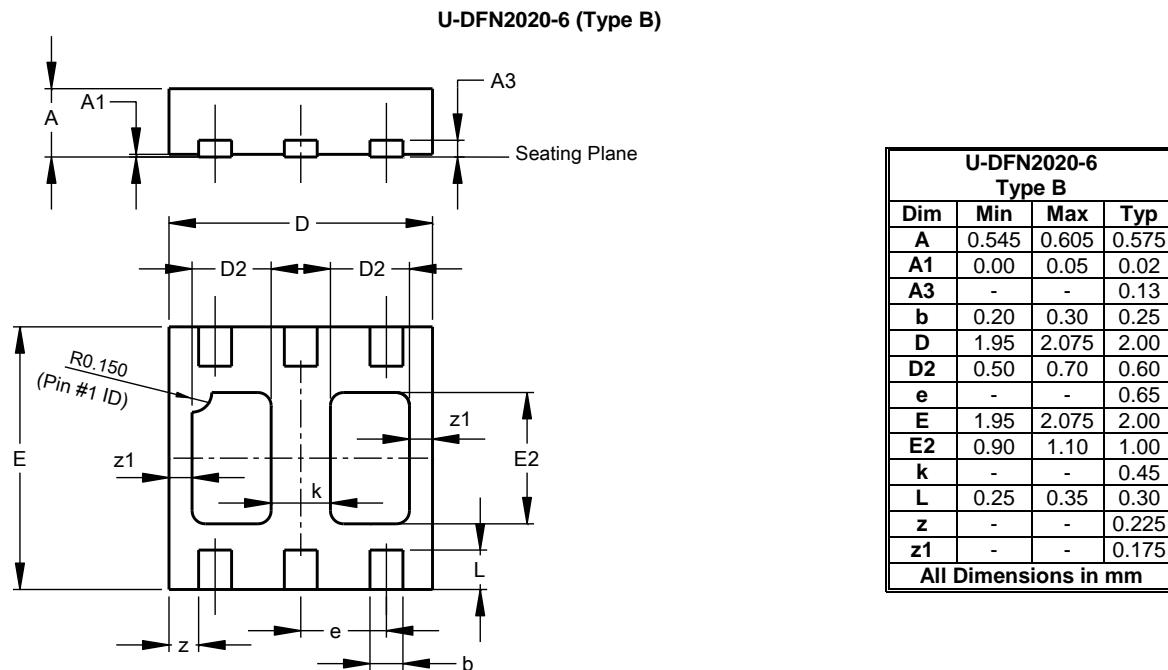


Figure 6 On-Resistance Variation with Temperature



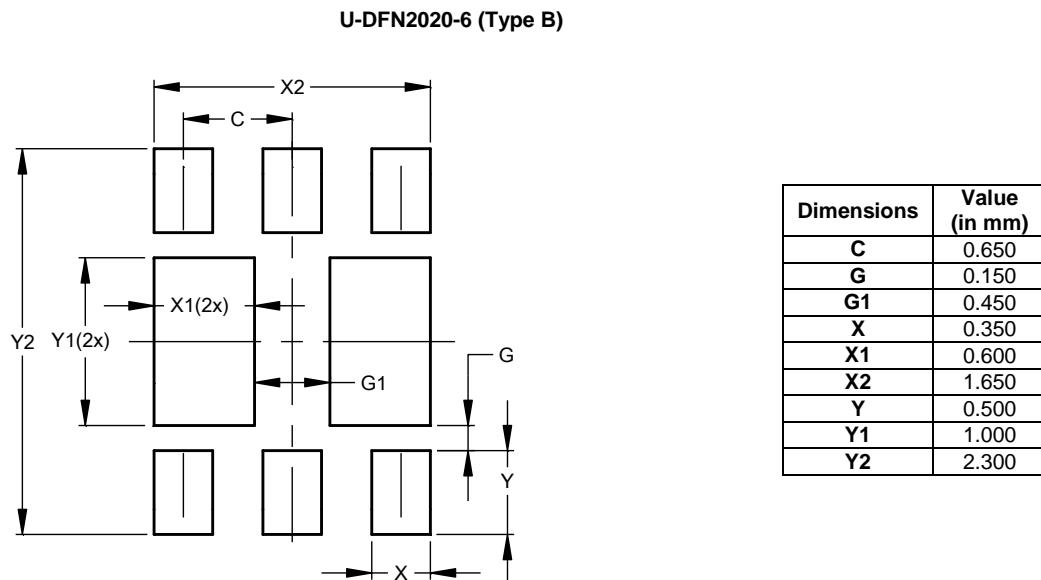
## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



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